# High Performance 12-Bit, 250/210/170/125MSPS ADC

#### **General Description**

The KAD5512HP is the high-performance member of the KAD5512 family of 12-bit analog-to-digital converters. Designed with Kenet's proprietary *FemtoCharge®* technology on a standard CMOS process, the family supports sampling rates of up to 250MSPS. The KAD5512HP is part of a pin-compatible portfolio of 10, 12 and 14-bit A/Ds with sample rates ranging from 125MSPS to 500MSPS.

A serial peripheral interface (SPI) port allows for extensive configurability, as well as fine control of various parameters such as gain and offset.

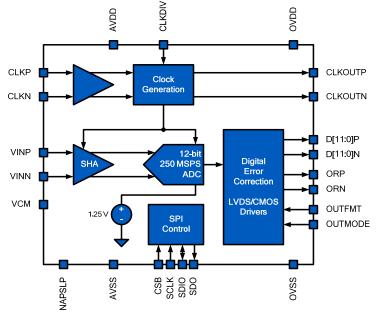
Digital output data is presented in selectable LVDS or CMOS formats. The KAD5512HP is available in 72and 48-contact QFN packages with an exposed paddle. Operating from a 1.8V supply, performance is specified over the full industrial temperature range (-40 to +85°C).

#### Features

- Pin-Compatible with the KAD5512P family, offering 2.5dB higher SNR
- Programmable Gain, Offset and Skew control
- 950MHz Analog Input Bandwidth
- 60fs Clock Jitter
- Over-Range Indicator
- Selectable Clock Divider: ÷1, ÷2 or ÷4
- Clock Phase Selection
- Nap and Sleep Modes
- Two's Complement, Gray Code or Binary Data Format
- DDR LVDS-Compatible or LVCMOS Outputs
- Programmable Built-in Test Patterns
- Single-Supply 1.8V Operation

#### **Applications**

- Power Amplifier Linearization
- Radar and Satellite Antenna Array Processing
- Broadband Communications
- High-Performance Data Acquisition
- Communications Test Equipment
- WiMAX and Microwave Receivers



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### **Key Specifications**

- SNR = 67.2dBFS for f<sub>IN</sub> = 124MHz (-1dBFS)
- SFDR = 81dBc for f<sub>IN</sub> = 124MHz (-1dBFS)
- Power consumption
  - 407/324mW @ 250/125MSPS (SDR Mode)
  - 368/288mW @ 250/125MSPS (DDR Mode)

#### **Pin-Compatible Family**

| Model                     | Resolution | Speed (MSPS) |
|---------------------------|------------|--------------|
| KAD5514P-25               | 14         | 250          |
| KAD5514P-21               | 14         | 210          |
| KAD5514P-17               | 14         | 170          |
| KAD5514P-12               | 14         | 125          |
| KAD5512P-50               | 12         | 500          |
| KAD5512P-25, KAD5512HP-25 | 12         | 250          |
| KAD5512P-21, KAD5512HP-21 | 12         | 210          |
| KAD5512P-17, KAD5512HP-17 | 12         | 170          |
| KAD5512P-12, KAD5512HP-12 | 12         | 125          |
| KAD5510P-50               | 10         | 500          |

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## **Electrical Specifications**

All specifications apply under the following conditions unless otherwise noted: AVDD = 1.8V, OVDD = 1.8V,  $T_A = -40^{\circ}C$  to +85°C (typical specifications at 25°C),  $A_{IN} = -1$ dBFS,  $f_{SAMPLE} =$  Maximum Conversion Rate (per speed grade).

### **DC Specifications**

|  |                  |  | KAD  | 05512H | P-25 | KAD  | 05512H | P-21 | KAD  | 05512H | P-17 | KAD5512HP-12 |       |      |                 |
|--|------------------|--|------|--------|------|------|--------|------|------|--------|------|--------------|-------|------|-----------------|
| Parameter                                      | Symbol           | Conditions                             | Min  | Тур    | Max  | Min  | Тур    | Max  | Min  | Тур    | Max  | Min          | Тур   | Max  | Units           |
| Analog Input                                   | •                | •                                      |      |        |      |      |        |      |      |        |      |              |       |      |                 |
| Full-Scale Analog Input Range                  | V <sub>FS</sub>  | Differential                           | 1.40 | 1.47   | 1.54 | 1.40 | 1.47   | 1.54 | 1.40 | 1.47   | 1.54 | 1.40         | 1.47  | 1.54 | V <sub>PP</sub> |
| Input Resistance                               | Rin              | Differential                           |      | 500    |      |      | 500    |      |      | 500    |      |              | 500   |      | Ω               |
| Input Capacitance                              | CIN              | Differential                           |      | 2.6    |      |      | 2.6    |      |      | 2.6    |      |              | 2.6   |      | pF              |
| Full Scale Range Temp. Drift                   | A <sub>VTC</sub> | Full Temp                              |      | 90     |      |      | 90     |      |      | 90     |      |              | 90    |      | ppm/°C          |
| Input Offset Voltage                           | V <sub>OS</sub>  |  | -10  | ±2     | 10   | -10  | ±2     | 10   | -10  | ±2     | 10   | -10          | ±2    | 10   | mV              |
| Gain Error                                     | EG               |  |      | ±2     |      |      | ±2     |      |      | ±2     |      |              | ±2    |      | %               |
| Common-Mode Output Voltage                     | V <sub>CM</sub>  |  |      | 0.535  |      |      | 0.535  |      |      | 0.535  |      |              | 0.535 |      | V               |
| Power Requirements                             |                  |  |      |        |      |      |        |      |      |        |      |              |       |      |                 |
| 1.8V Analog Supply Voltage                     | AVDD             |  | 1.7  | 1.8    | 1.9  | 1.7  | 1.8    | 1.9  | 1.7  | 1.8    | 1.9  | 1.7          | 1.8   | 1.9  | V               |
| 1.8V Digital Supply Voltage                    | OVDD             |  | 1.7  | 1.8    | 1.9  | 1.7  | 1.8    | 1.9  | 1.7  | 1.8    | 1.9  | 1.7          | 1.8   | 1.9  | V               |
| 1.8V Analog Supply Current                     | IAVDD            |  |      | 158    | 167  |      | 146    | 155  |      | 133    | 142  |              | 118   | 126  | mA              |
| 1.8V Digital Supply Current <sup>1</sup> (SDR) | Iovdd            | 3mA LVDS                               |      | 68     | 76   |      | 66     | 74   |      | 64     | 72   |              | 62    | 70   | mA              |
| 1.8V Digital Supply Current <sup>1</sup> (DDR) | Iovdd            | 3mA LVDS                               |      | 46     |      |      | 44     |      |      | 43     |      |              | 42    |      | mA              |
| Power Supply Rejection Ratio                   | PSRR             | 30MHz,<br>200mVpp<br>signal on<br>AVDD |      | -36    |      |      | -36    |      |      | -36    |      |              | -36   |      | dB              |
| Power Dissipation                              |                  |  |      |        |      |      |        |      |      |        |      |              |       |      |                 |
| Normal Mode (SDR)                              | PD               | 3mA LVDS                               |      | 407    | 438  |      | 382    | 413  |      | 355    | 386  |              | 324   | 353  | mW              |
| Normal Mode (DDR)                              | PD               | 3mA LVDS                               |      | 368    | 301  |      | 342    | 279  |      | 317    | 256  |              | 288   | 227  | mW              |
| Nap Mode                                       | PD               |  |      | 134    | 146  |      | 129    | 140  |      | 124    | 136  |              | 114   | 128  | mW              |
| Sleep Mode                                     | PD               |  |      | 14     | 16   |      | 13     | 15   |      | 12     | 14   |              | 12    | 13   | mW              |

1. Digital Supply Current is dependent upon the capacitive loading of the digital outputs. IOVDD specifications apply for 10pF load on each digital output.



## AC Specifications<sup>1</sup>

|                                      |        |                          | KAI  | D5512H | P-25 | KAD  | D5512H | P-21 | KAI  | D5512H | P-17 | KAD  | 05512H | P-12 |       |
|--------------------------------------|--------|--------------------------|------|--------|------|------|--------|------|------|--------|------|------|--------|------|-------|
| Parameter                            | Symbol | Conditions               | Min  | Тур    | Max  | Units |
| Differential Nonlinearity            | DNL    |                          | -1.0 | ±0.6   |      | -1.0 | ±0.6   |      | -1.0 | ±0.6   |      | -1.0 | ±0.6   |      | LSB   |
| Integral Nonlinearity                | INL    |                          |      | ±1.3   |      |      | ±1.3   |      |      | ±1.4   |      |      | ±2.0   |      | LSB   |
| Minimum Conversion Rate <sup>2</sup> | fs MIN |                          |      |        | 40   |      |        | 40   |      |        | 40   |      |        | 40   | MSPS  |
| Maximum Conversion Rate              | fs MAX |                          | 250  |        |      | 210  |        |      | 170  |        |      | 125  |        |      | MSPS  |
| Signal-to-Noise Ratio                | SNR    | $f_{IN} = 10MHz$         |      | 67.5   |      |      | 68.0   |      |      | 68.4   |      |      | 68.7   |      | dBFS  |
|                                      |        | f <sub>IN</sub> = 70MHz  |      | 67.4   |      |      | 67.8   |      |      | 68.3   |      |      | 68.6   |      | dBFS  |
|                                      |        | f <sub>IN</sub> = 105MHz | 65.0 | 67.2   |      | 65.5 | 67.6   |      | 66.2 | 68.0   |      | 66.7 | 68.2   |      | dBFS  |
|                                      |        | f <sub>IN</sub> = 230MHz |      | 66.9   |      |      | 67.6   |      |      | 68.0   |      |      | 68.0   |      | dBFS  |
|                                      |        | $f_{IN} = 400 MHz$       |      | 65.9   |      |      |        |      |      |        |      |      | 65.3   |      | dBFS  |
|                                      |        | $f_{IN} = 995 MHz$       |      | 62.2   |      |      |        |      |      |        |      |      | 61.2   |      | dBFS  |
| Signal-to-Noise and Distortion       | SINAD  | $f_{IN} = 10MHz$         |      | 67.2   |      |      | 67.7   |      |      | 68.0   |      |      | 68.3   |      | dBFS  |
|                                      |        | f <sub>IN</sub> = 70MHz  |      | 67.1   |      |      | 67.5   |      |      | 68.0   |      |      | 68.3   |      | dBFS  |
|                                      |        | $f_{IN} = 105 MHz$       | 64.5 | 66.6   |      | 65.0 | 67.0   |      | 65.7 | 67.4   |      | 66.2 | 67.6   |      | dBFS  |
|                                      |        | $f_{IN} = 230 MHz$       |      | 66.4   |      |      | 67.9   |      |      | 68.3   |      |      | 68.3   |      | dBFS  |
|                                      |        | $f_{IN} = 400 MHz$       |      | 64.4   |      |      |        |      |      |        |      |      | 64.3   |      | dBFS  |
|                                      |        | $f_{IN} = 995 MHz$       |      | 55.0   |      |      |        |      |      |        |      |      | 57.0   |      | dBFS  |
| Effective Number of Bits             | ENOB   | $f_{IN} = 10MHz$         |      | 10.9   |      |      | 11.0   |      |      | 11.0   |      |      | 11.1   |      | Bits  |
|                                      |        | $f_{IN} = 70 MHz$        |      | 10.9   |      |      | 10.9   |      |      | 11.0   |      |      | 11.1   |      | Bits  |
|                                      |        | $f_{IN} = 105 MHz$       | 10.4 | 10.8   |      | 10.5 | 10.8   |      | 10.6 | 10.9   |      | 10.7 | 10.9   |      | Bits  |
|                                      |        | $f_{IN} = 230 MHz$       |      | 10.7   |      |      | 11.0   |      |      | 11.1   |      |      | 11.1   |      | Bits  |
|                                      |        | $f_{IN} = 400 MHz$       |      | 10.4   |      |      |        |      |      |        |      |      | 10.4   |      | Bits  |
|                                      |        | $f_{IN} = 995 MHz$       |      | 8.8    |      |      |        |      |      |        |      |      | 9.2    |      | Bits  |
| Spurious-Free Dynamic Range          | SFDR   | $f_{IN} = 10MHz$         |      | 85     |      |      | 84     |      |      | 85     |      |      | 84     |      | dBc   |
|                                      |        | f <sub>IN</sub> = 70MHz  |      | 84     |      |      | 83     |      |      | 82     |      |      | 82     |      | dBc   |
|                                      |        | $f_{IN} = 105 MHz$       | 70   | 83     |      | 70   | 80     |      | 70   | 78     |      | 70   | 77     |      | dBc   |
|                                      |        | $f_{IN} = 230 MHz$       |      | 77     |      |      | 77     |      |      | 76     |      |      | 76     |      | dBc   |
|                                      |        | $f_{IN} = 400 MHz$       |      | 71     |      |      |        |      |      |        |      |      | 78     |      | dBc   |
|                                      |        | $f_{IN} = 995 MHz$       |      | 57     |      |      |        |      |      |        |      |      | 60     |      | dBc   |
| Intermodulation Distortion           | IMD    | f <sub>IN</sub> = 70MHz  |      | -91.5  |      |      |        |      |      |        |      |      | -96.5  |      | dBFS  |
|                                      |        | $f_{IN} = 170 MHz$       |      | -86.5  |      |      |        |      |      |        |      |      | -93.0  |      | dBFS  |
| Word Error Rate                      | WER    |                          |      | 10-12  |      |      | 10-12  |      |      | 10-12  |      |      | 10-12  |      |       |
| Full Power Bandwidth                 | FPBW   |                          |      | 950    |      |      | 950    |      |      | 950    |      |      | 950    |      | MHz   |

1. AC Specifications apply after internal calibration of the ADC is invoked at the given sample rate and temperature. Refer to the **Power-On Calibration** and **User-Initiated Reset** sections for more details.

2. The DLL Range setting must be changed for low speed operation. See the **Serial Peripheral Interface** section for more detail.



## **Digital Specifications**

| Parameter                    | Symbol          | Conditions               | Min      | Тур      | Max | Units |
|------------------------------|-----------------|--------------------------|----------|----------|-----|-------|
| Inputs                       |                 |                          |          |          |     |       |
| Input Current High (RESETN)  | Іін             | V <sub>IN</sub> = 1.8V   | 0        | 1        | 10  | μA    |
| Input Current Low (RESETN)   | hı.             | $V_{IN} = 0V$            | -25      | -12      | -5  | μA    |
| Input Current High (OUTMODE, | liH             |                          | 15       | 25       | 40  | μA    |
| Input Current Low (OUTMODE,  | IIL             |                          | -40      | 25       | -15 | μA    |
| Input Capacitance            | C <sub>DI</sub> |                          |          | 3        |     | pF    |
| LVDS Outputs                 |                 | •                        | ·        |          |     | •     |
| Differential Output Voltage  | VT              | 3mA Mode                 |          | 620      |     | mVpp  |
| Output Offset Voltage        | V <sub>OS</sub> | 3mA Mode                 | 950      | 965      | 980 | mV    |
| Output Rise Time             | t <sub>R</sub>  |                          |          | 500      |     | ps    |
| Output Fall Time             | t⊧              |                          |          | 500      |     | ps    |
| CMOS Outputs                 |                 | •                        | ·        |          |     | •     |
| Voltage Output High          | V <sub>OH</sub> | I <sub>OH</sub> = -500µА | OVDD-0.3 | OVDD-0.1 |     | V     |
| Voltage Output Low           | V <sub>OL</sub> | I <sub>OL</sub> = 1mA    |          | 0.1      | 0.3 | V     |
| Output Rise Time             | t <sub>R</sub>  |                          |          | 1.8      |     | ns    |
| Output Fall Time             | t⊧              |                          |          | 1.4      |     | ns    |

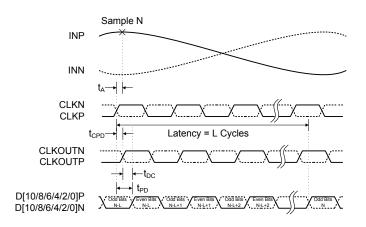


#### Absolute Maximum Ratings<sup>1</sup>

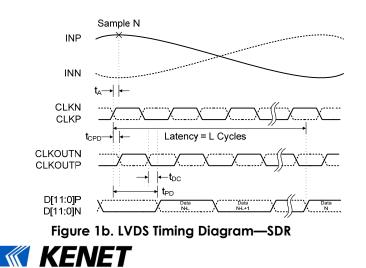
| Parameter             | Min  | Max        | Unit |
|-----------------------|------|------------|------|
| AVDD to AVSS          | -0.4 | 2.1        | V    |
| OVDD to OVSS          | -0.4 | 2.1        | V    |
| AVSS to OVSS          | -0.3 | 0.3        | V    |
| Analog Inputs to AVSS | -0.4 | AVDD + 0.3 | V    |
| Clock Inputs to AVSS  | -0.4 | AVDD + 0.3 | V    |
| Logic Input to AVSS   | -0.4 | OVDD + 0.3 | V    |
| Logic Inputs to OVSS  | -0.4 | OVDD + 0.3 | V    |
| Operating Temperature | -40  | 85         | °C   |
| Storage Temperature   | -65  | 150        | °C   |
| Junction Temperature  |      | 150        | °C   |

1. Exposing the device to levels in excess of the maximum ratings may cause permanent damage. Exposure to maximum conditions for extended periods may affect device reliability.

### **Timing Diagrams**







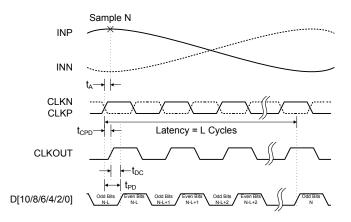


Figure 2a. CMOS Timing Diagram—DDR

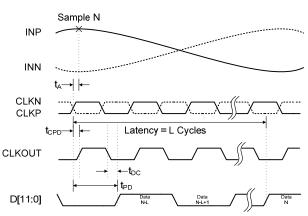


Figure 2b. CMOS Timing Diagram—SDR

### **Switching Specifications**

| Parameter   | Condition         | Symbol           | Min  | Тур | Max | Units  |
|---|-------------------|------------------|------|-----|-----|--------|
| ADC Output  |                   |                  |      |     |     | ł      |
| Aperture Delay                                    |                   | t <sub>A</sub>   |      | 375 |     | ps     |
| RMS Aperture Jitter                               |                   | jА               |      | 60  |     | fs     |
| Output Clock to Data Propagation Delay, LVDS Mode | DDR, Rising Edge  | t <sub>DC</sub>  | -260 | -50 | 120 | ps     |
|   | DDR, Falling Edge | t <sub>DC</sub>  | -160 | 10  | 230 | ps     |
|   | SDR, Falling Edge | t <sub>DC</sub>  | -260 | -40 | 230 | ps     |
| Output Clock to Data Propagation Delay, CMOS Mode | DDR, Rising Edge  | t <sub>DC</sub>  | -220 | -10 | 200 | ps     |
|   | DDR, Falling Edge | t <sub>DC</sub>  | -310 | -90 | 110 | ps     |
|   | SDR, Falling Edge | t <sub>DC</sub>  | -310 | -50 | 200 | ps     |
| Latency (Pipeline Delay)                          |                   | L                |      | 8.5 |     | cycles |
| Over Voltage Recovery                             |                   | tovr             |      | 1   |     | cycles |
| SPI Interface <sup>1,2</sup>                      |                   |                  |      |     |     |        |
| SCLK Period                                       | Write Operation   | t <sub>сік</sub> | 64   |     |     | ns     |
|   | Read Operation    | tсıк             | 264  |     |     | ns     |
| SCLK Duty Cycle (tHI/tclk or tLo/tclk)            | Read or Write     |                  | 25   | 50  | 75  | %      |
| SCLK↑ to CSB↓ Setup Time                          | Read or Write     | ts               | -4   |     |     | ns     |
| SCLK† to CSB† Hold Time                           | Read or Write     | t <sub>H</sub>   | -12  |     |     | ns     |
| SCLK↑ to Data Setup Time                          | Read or Write     | t <sub>DS</sub>  | -4   |     |     | ns     |
| SCLK↑ to Data Hold Time                           | Read or Write     | t <sub>DH</sub>  | -12  |     |     | ns     |

1. SPI Interface timing is directly proportional to the ADC sample period (ts). Values above reflect multiples of a 4ns sample period, and must be scaled proportionally for lower sample rates.

2. The SPI may operate asynchronously with respect to the ADC sample clock.

#### **Thermal Impedance**

| Parameter                        | Symbol      | 48-QFN Typ | 72-QFN Typ | Unit |
|----------------------------------|-------------|------------|------------|------|
| Junction to Ambient <sup>3</sup> | $\Phi_{JA}$ | 35         | 27         | °C/W |

3. Paddle soldered to ground plane.

ESD



Electrostatic charge accumulates on humans, tools and equipment and may discharge through any metallic package contacts (pins, balls, exposed paddle, etc.) of an integrated circuit. Industry-standard protection techniques have been utilized in the design of this product. However, reasonable care must be taken in the storage and handling of ESD sensitive products. Contact Kenet for the specific ESD sensitivity rating of this product.



# Pin Descriptions—72QFN

| Pin #                      | LVDS [LVCMOS] Name            | LVDS [LVCMOS] Function   |
|----------------------------|-------------------------------|--|
| 1, 6, 12, 19, 24, 71       | AVDD                          | 1.8V Analog Supply   |
| 2-5, 13, 14, 17, 18, 28-31 | DNC                           | Do Not Connect   |
| 7, 8, 11, 72               | AVSS                          | Analog Ground  |
| 9, 10                      | VINN, VINP                    | Analog Input Negative, Positive  |
| 15                         | VCM                           | Common Mode Output   |
| 16                         | CLKDIV                        | Clock Divider Control  |
| 20, 21                     | CLKP, CLKN                    | Clock Input True, Complement   |
| 22                         | OUTMODE                       | Output Mode (LVDS, LVCMOS)   |
| 23                         | NAPSLP                        | Power Control (Nap, Sleep modes)                                       |
| 25                         | RESETN                        | Power On Reset (Active Low)  |
| 26, 45, 55, 65             | OVSS                          | Output Ground  |
| 27, 36, 56                 | OVDD                          | 1.8V Output Supply   |
| 32, 33                     | DON, DOP [NC, D0]             | LVDS Bit 0 (LSB) Output Complement, True [NC, LVCMOS Bit 0]            |
| 34, 35                     | D1N, D1P [NC, D1]             | LVDS Bit 1 Output Complement, True [NC, LVCMOS Bit 1]                  |
| 37, 38                     | D2N, D2P [NC, D2]             | LVDS Bit 2 Output Complement, True [NC, LVCMOS Bit 2]                  |
| 39, 40                     | D3N, D3P [NC, D3]             | LVDS Bit 3 Output Complement, True [NC, LVCMOS Bit 3]                  |
| 41, 42                     | D4N, D4P [NC, D4]             | LVDS Bit 4 Output Complement, True [NC, LVCMOS Bit 4]                  |
| 43, 44                     | D5N, D5P [NC, D5]             | LVDS Bit 5 Output Complement, True [NC, LVCMOS Bit 5]                  |
| 46                         | RLVDS                         | LVDS Bias Resistor (connect to OVSS with a 10k $\Omega$ , 1% resistor) |
| 47, 48                     | CLKOUTN, CLKOUTP [NC, CLKOUT] | LVDS Clock Output Complement, True [NC, LVCMOS CLKOUT]                 |
| 49, 50                     | D6N, D6P [NC, D6]             | LVDS Bit 6 Output Complement, True [NC, LVCMOS Bit 6]                  |
| 51, 52                     | D7N, D7P [NC, D7]             | LVDS Bit 7 Output Complement, True [NC, LVCMOS Bit 7]                  |
| 53, 54                     | D8N, D8P [NC, D8]             | LVDS Bit 8 Output Complement, True [NC, LVCMOS Bit 8]                  |
| 57, 58                     | D9N, D9P [NC, D9]             | LVDS Bit 9 Output Complement, True [NC, LVCMOS Bit 9]                  |
| 59, 60                     | D10N, D10P [NC, D10]          | LVDS Bit 10 Output Complement, True [NC, LVCMOS Bit 10]                |
| 61, 62                     | D11N, D11P [NC, D11]          | LVDS Bit 11(MSB) Output Complement, True [NC, LVCMOS Bit 11]           |
| 63, 64                     | ORN, ORP [NC, OR]             | LVDS Over Range Complement, True [NC, LVCMOS Over Range]               |
| 66                         | SDO                           | SPI Serial Data Output (4.7kΩ pull-up to OVDD is required)             |
| 67                         | CSB                           | SPI Chip Select (active low)   |
| 68                         | SCLK                          | SPI Clock  |
| 69                         | SDIO                          | SPI Serial Data Input/Output   |
| 70                         | OUTFMT                        | Output Data Format (Two's Comp., Gray Code, Offset Binary)             |
| Exposed Paddle             | AVSS                          | Analog Ground  |

LVCMOS Output Mode Functionality is shown in brackets (NC = No Connection)



## Pin Configuration—72QFN

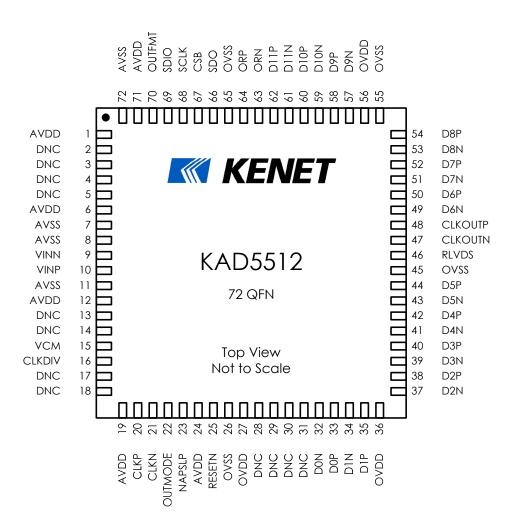


Figure 3. 72 QFN Pin Configuration



## Pin Descriptions—48QFN

| Pin #            | LVDS [LVCMOS] Name            | LVDS [LVCMOS] Function  |
|------------------|-------------------------------|---|
| 1, 9, 13, 17, 47 | AVDD                          | 1.8V Analog Supply  |
| 2-4, 11, 21, 22  | DNC                           | Do Not Connect  |
| 5, 8, 12, 48     | AVSS                          | Analog Ground   |
| 6, 7             | VINN, VINP                    | Analog Input Negative, Positive                                       |
| 10               | VCM                           | Common Mode Output  |
| 14, 15           | CLKP, CLKN                    | Clock Input True, Complement  |
| 16               | NAPSLP                        | Power Control (Nap, Sleep modes)                                      |
| 18               | RESETN                        | Power On Reset (Active Low)   |
| 19, 29, 42       | OVSS                          | Output Ground   |
| 20, 37           | OVDD                          | 1.8V Output Supply  |
| 23, 24           | DON, DOP [NC, D0]             | LVDS Bit 0 (LSB) Output Complement, True [NC, LVCMOS Bit 0]           |
| 25, 26           | D1N, D1P [NC, D1]             | LVDS Bit 1 Output Complement, True [NC, LVCMOS Bit 1]                 |
| 27, 28           | D2N, D2P [NC, D2]             | LVDS Bit 2 Output Complement, True [NC, LVCMOS Bit 2]                 |
| 30               | RLVDS                         | LVDS Bias Resistor (connect to OVSS with a 10k $\Omega,$ 1% resistor) |
| 31, 32           | CLKOUTN, CLKOUTP [NC, CLKOUT] | LVDS Clock Output Complement, True [NC, LVCMOS CLKOUT]                |
| 33, 34           | D3N, D3P [NC, D3]             | LVDS Bit 3 Output Complement, True [NC, LVCMOS Bit 3]                 |
| 35, 36           | D4N, D4P [NC, D4]             | LVDS Bit 4 Output Complement, True [NC, LVCMOS Bit 4]                 |
| 38, 39           | D5N, D5P [NC, D5]             | LVDS Bit 5 Output Complement, True [NC, LVCMOS Bit 5]                 |
| 40, 41           | ORN, ORP [NC, OR]             | LVDS Over Range Complement, True [NC, LVCMOS Over Range]              |
| 43               | SDO                           | SPI Serial Data Output (4.7kΩ pull-up to OVDD is required)            |
| 44               | CSB                           | SPI Chip Select (active low)  |
| 45               | SCLK                          | SPI Clock   |
| 46               | SDIO                          | SPI Serial Data Input/Output  |
| Exposed Paddle   | AVSS                          | Analog Ground   |

LVCMOS Output Mode Functionality is shown in brackets (NC = No Connection)



## Pin Configuration—48QFN

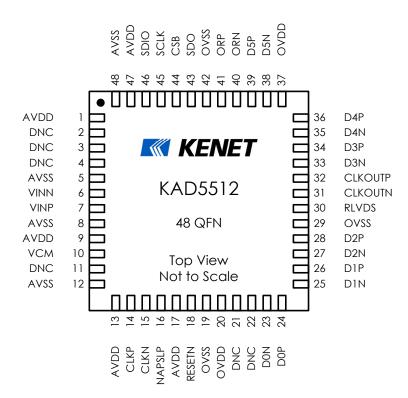
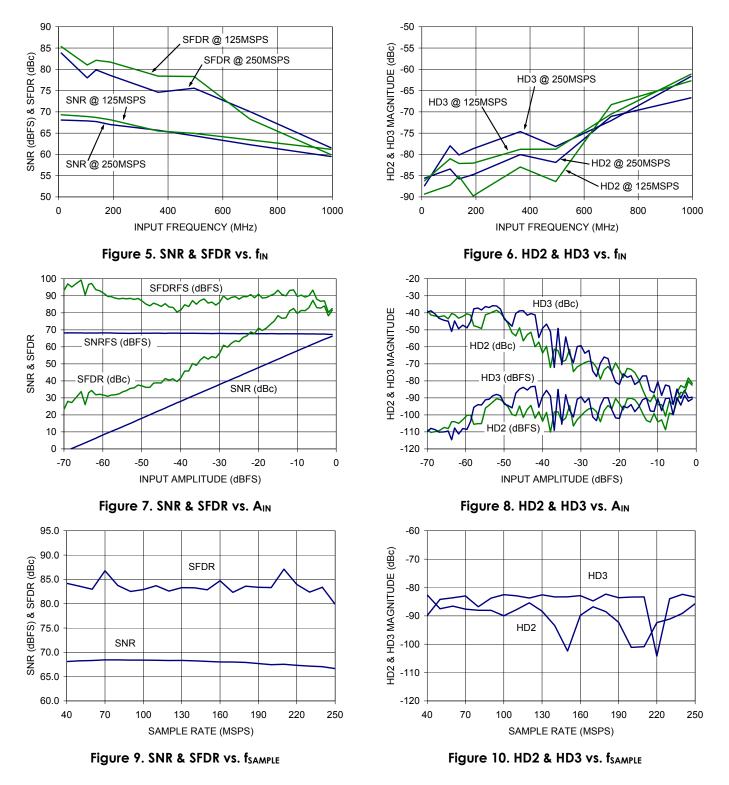


Figure 4. 48QFN Pin Configuration



## **Typical Performance Curves**

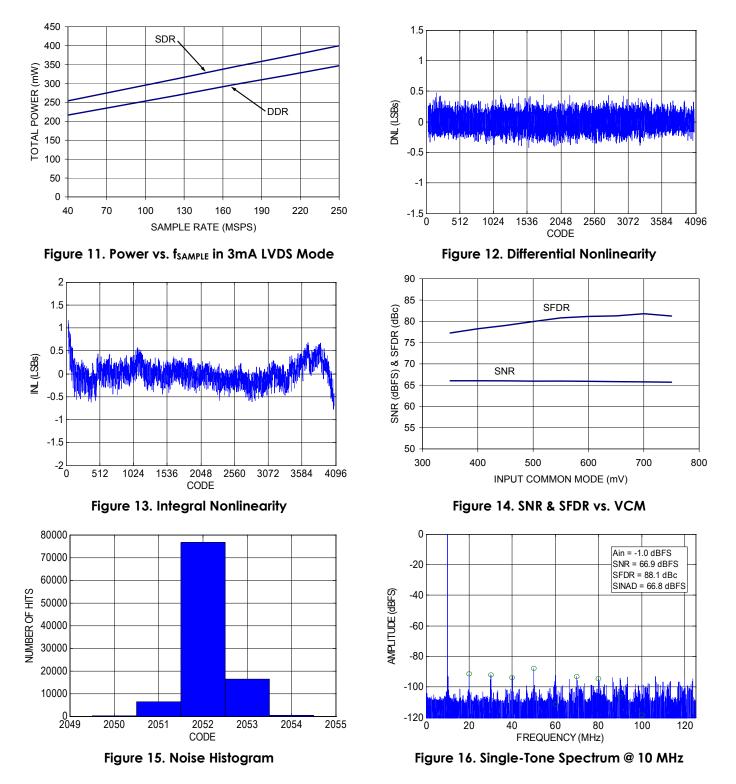
All Typical Performance Characteristics apply under the following conditions unless otherwise noted: AVDD = OVDD = 1.8V,  $T_A = +25^{\circ}C$ ,  $A_{IN} = -1$  dBFS,  $f_{IN} = 105$  MHz,  $f_{SAMPLE} = Maximum$  Conversion Rate (per speed grade).





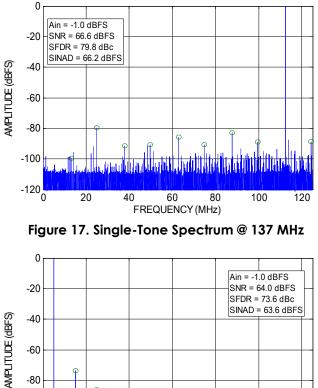
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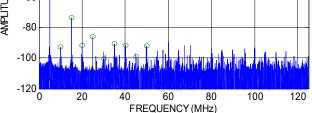


Figure 19. Single-Tone Spectrum @ 495 MHz

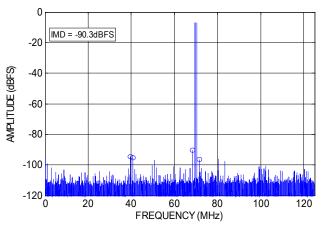


Figure 21. Two-Tone Spectrum @ 70 MHz

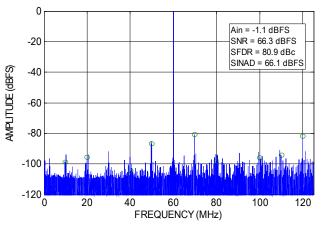


Figure 18. Single-Tone Spectrum @ 190 MHz

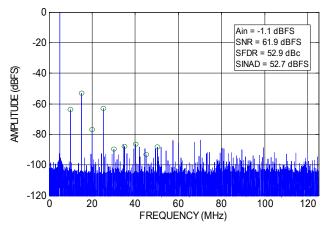


Figure 20. Single-Tone Spectrum @ 995 MHz

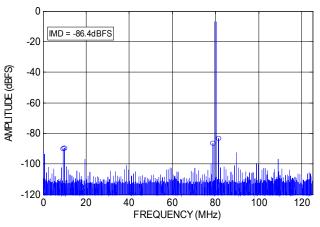


Figure 22. Two-Tone Spectrum @ 170 MHz



## **Functional Description**

The KAD5512HP is based upon a 12-bit, 250MSPS A/D converter core that utilizes a pipelined successive approximation architecture (Figure 23). The input voltage is captured by a Sample-Hold Amplifier (SHA) and converted to a unit of charge. Proprietary charge-domain techniques are used to successively compare the input to a series of reference charges. Decisions made during the successive approximation operations determine the digital code for each input value. The converter pipeline requires six samples to produce a result. Digital error correction is also applied, resulting in a total latency of seven and one half clock cycles. This is evident to the user as a time lag between the start of a conversion and the data being available on the digital outputs.

The KAD5512HP family offers 2.5dB improvement in SNR over the KAD5512P by simultaneously sampling the input signal with two ADC cores in parallel and summing the digital result. Since the input signal is correlated between the two cores and noise is not, an increase in SNR is achieved. As a result of this architecture, indexed SPI operations must be executed on each core in series. Refer to the **Indexed Device Configuration/Control** section for more details.

## **Power-On Calibration**

The ADC performs a self-calibration at start-up. An internal power-on-reset (POR) circuit detects the supply voltage ramps and initiates the calibration when the analog and digital supply voltages are above a threshold. The following conditions must be adhered to for the power-on calibration to execute successfully:

- A frequency-stable conversion clock must be applied to the CLKP/CLKN pins
- DNC pins (especially 3, 4 and 18) must not be pulled up or down
- SDO (pin 66) must be high

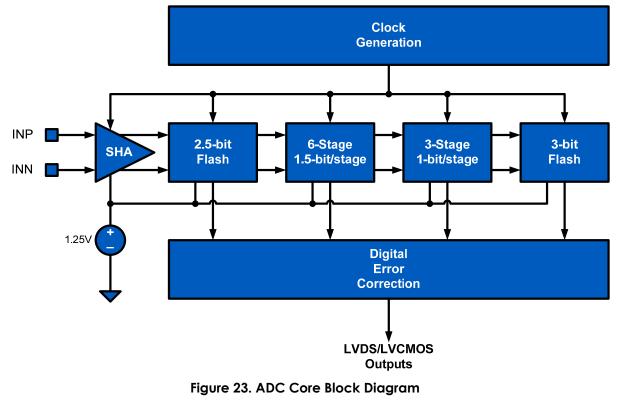
at power-up.

RESETN (pin 25) must begin low

• SPI communications must not be attempted A user-initiated reset can subsequently be invoked in the event that the above conditions cannot be met

The SDO pin requires an external  $4.7k\Omega$  pull-up to OVDD. If the SDO pin is pulled low externally during power-up, calibration will not be executed properly.

After the power supply has stabilized the internal POR releases RESETN and an internal pull-up pulls it high, which starts the calibration sequence. If a subsequent user-initiated reset is required, the RESETN pin should be connected to an open-drain driver with a drive strength of less than 0.5mA.



The calibration sequence is initiated on the rising edge of RESETN, as shown in Figure 24. The overrange output (OR) is set high once RESETN is pulled low, and remains in that state until calibration is complete. The OR output returns to normal operation at that time, so it is important that the analog input be within the converter's full-scale range to observe the transition. If the input is in an over-range condition the OR pin will stay high, and it will not be possible to detect the end of the calibration cycle.

While RESETN is low, the output clock (CLKOUTP/CLKOUTN) is set low. Normal operation of the output clock resumes at the next input clock edge (CLKP/CLKN) after RESETN is deasserted. At 250MSPS the nominal calibration time is 200ms, while the maximum calibration time is 550ms.

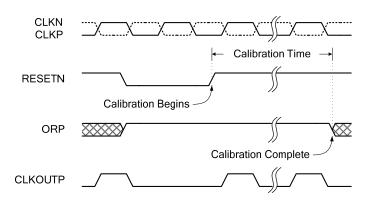


Figure 24. Calibration Timing

## **User-Initiated Reset**

Recalibration of the ADC can be initiated at any time by driving the RESETN pin low for a minimum of one clock cycle. An open-drain driver with a drive strength of less than 0.5mA is recommended. As is the case during power-on reset, the SDO, RESETN and DNC pins must be in the proper state for the calibration to successfully execute.

The performance of the KAD5512HP changes with variations in temperature, supply voltage or sample rate. The extent of these changes may necessitate recalibration, depending on system performance requirements. Best performance will be achieved by recalibrating the ADC under the environmental conditions at which it will operate.

A supply voltage variation of less than 100mV will generally result in an SNR change of less than 0.5dBFS and SFDR change of less than 3dBc.

In situations where the sample rate is not constant, best results will be obtained if the device is calibrated

at the highest sample rate. Reducing the sample rate by less than 80MSPS will typically result in an SNR change of less than 0.5dBFS and an SFDR change of less than 3dBc.

Figures 25 and 26 show the effect of temperature on SNR and SFDR performance without recalibration. In each plot the ADC is calibrated at 25°C and temperature is varied over the operating range without recalibrating. The average change in SNR/SFDR is shown, relative to the 25°C value.

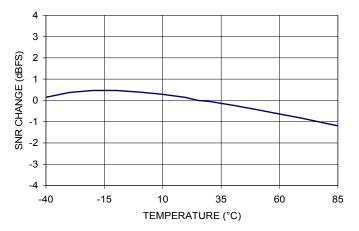


Figure 25. SNR Performance vs. Temperature after 25°C Calibration

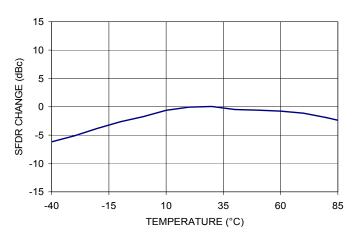


Figure 26. SFDR Performance vs. Temperature after 25°C Calibration

## **Analog Input**

A single fully differential input (VINP/VINN) connects to the sample and hold amplifier (SHA) of each unit ADC. The ideal full-scale input voltage is 1.45V, centered at the VCM voltage of 0.535V as shown in Figure 27.



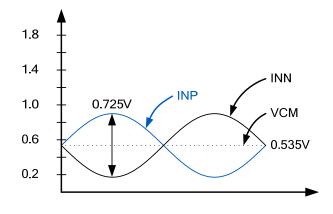


Figure 27. Analog Input Range

Best performance is obtained when the analog inputs are driven differentially. The common-mode output voltage, VCM, should be used to properly bias the inputs as shown in Figures 28 through 30. An RF transformer will give the best noise and distortion performance for wideband and/or high intermediate frequency (IF) inputs. Two different transformer input schemes are shown in Figures 28 and 29.

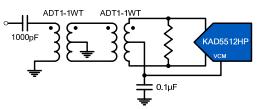


Figure 28. Transformer Input for General Purpose Applications

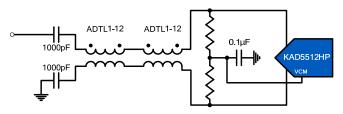


Figure 29. Transmission-line Transformer Input for High IF Applications

This dual transformer scheme is used to improve common-mode rejection, which keeps the commonmode level of the input matched to VCM. The value of the shunt resistor should be determined based on the desired load impedance. The differential input resistance of the KAD5512HP is  $500\Omega$ .

The SHA design uses a switched capacitor input stage (see Figure 43), which creates current spikes when the sampling capacitance is reconnected to the input voltage. This causes a disturbance at the input which must settle before the next sampling point. Lower source impedance will result in faster



settling and improved performance. Therefore a 1:1 transformer and low shunt resistance are recommended for optimal performance.

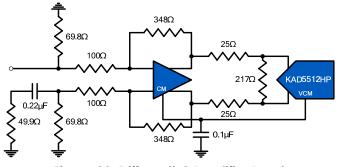


Figure 30. Differential Amplifier Input

A differential amplifier, as shown in Figure 30, can be used in applications that require dc-coupling. In this configuration the amplifier will typically dominate the achievable SNR and distortion performance.

## **Clock Input**

The clock input circuit is a differential pair (see Figure 44). Driving these inputs with a high level (up to  $1.8V_{PP}$  on each input) sine or square wave will provide the lowest jitter performance. A transformer with 4:1 impedance ratio will provide increased drive levels.

The recommended drive circuit is shown in Figure 31. A duty range of 40% to 60% is acceptable. The clock can be driven single-ended, but this will reduce the edge rate and may impact SNR performance. The clock inputs are internally self-biased to AVDD/2 to facilitate AC coupling.

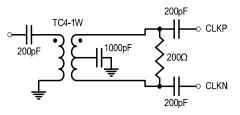


Figure 31. Recommended Clock drive

A selectable 2X frequency divider is provided in series with the clock input. The divider can be used in the 2X mode with a sample clock equal to twice the desired sample rate. This allows the use of the Phase Slip feature, which enables synchronization of multiple ADCs.

| CLKDIV Pin | Divide Ratio |
|------------|--------------|
| AVSS       | 2            |
| Float      | 1            |
| AVDD       | 4            |

#### Table 1. CLKDIV Pin Settings

The clock divider can also be controlled through the SPI port, which overrides the CLKDIV pin setting. Details on this are contained in the **Serial Peripheral Interface** section.

A delay-locked loop (DLL) generates internal clock signals for various stages within the charge pipeline. If the frequency of the input clock changes, the DLL may take up to 52µs to regain lock at 250MSPS. The lock time is inversely proportional to the sample rate.

The DLL has two ranges of operation, slow and fast. The slow range can be used for sample rates between 40MSPS and 100MSPS, while the default fast range can be used from 80MSPS to the maximum specified sample rate.

## Jitter

In a sampled data system, clock jitter directly impacts the achievable SNR performance. The theoretical relationship between clock jitter (t<sub>J</sub>) and SNR is shown in Equation 1 and is illustrated in Figure 32.

$$SNR = 20 \log_{10} \left( \frac{1}{2 \pi f_{IN} t_J} \right)$$

Equation 1.

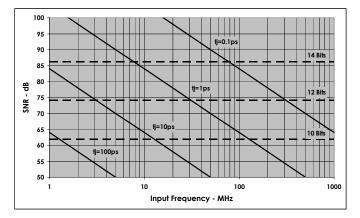


Figure 32. SNR vs. Clock Jitter

This relationship shows the SNR that would be achieved if clock jitter were the only non-ideal factor. In reality, achievable SNR is limited by internal factors such as linearity, aperture jitter and thermal



noise. Internal aperture jitter is the uncertainty in the sampling instant shown in Figure 1. The internal aperture jitter combines with the input clock jitter in a rootsum-square fashion, since they are not statistically correlated, and this determines the total jitter in the system. The total jitter, combined with other noise sources, then determines the achievable SNR.

## Voltage Reference

A temperature compensated voltage reference provides the reference charges used in the successive approximation operations. The full-scale range of each A/D is proportional to the reference voltage. The voltage reference is internally bypassed and is not accessible to the user.

## **Digital Outputs**

Output data is available as a parallel bus in LVDScompatible or CMOS modes. Additionally, the data can be presented in either double data rate (DDR) or single data rate (SDR) formats. The even numbered output bits are active in DDR mode. When CLKOUT is low the MSB and all odd bits are output, while on the high phase the LSB and all even bits are presented. Figures 1 and 2 show the timing relationships for LVDS/CMOS and DDR/SDR modes.

The 48-QFN package option contains six LVDS data outputs, and therefore can only support DDR mode.

Additionally, the drive current for LVDS mode can be set to a nominal 3 mA or a power-saving 2 mA. The lower current setting can be used in designs where the receiver is in close physical proximity to the ADC. The applicability of this setting is dependent upon the PCB layout, therefore the user should experiment to determine if performance degradation is observed.

The output mode and LVDS drive current are selected via the OUTMODE pin as shown in Table 2.

| OUTMODE Pin | Mode       |
|-------------|------------|
| AVSS        | LVCMOS     |
| Float       | LVDS, 3 mA |
| AVDD        | LVDS, 2 mA |

#### Table 2. OUTMODE Pin Settings

The output mode can also be controlled through the SPI port, which overrides the OUTMODE pin setting. Details on this are contained in the **Serial Peripheral Interface** section.

An external resistor creates the bias for the LVDS drivers. A  $10k\Omega$ , 1% resistor must be connected from the RLVDS pin to OVSS.

## **Over Range Indicator**

The over range (OR) bit is asserted when the output code reaches positive full-scale (e.g. 0xFFF in offset binary mode). The output code does not wrap around during an over-range condition. The OR bit is updated at the sample rate.

## **Power Dissipation**

The power dissipated by the KAD5512HP is primarily dependent on the sample rate and the output modes: LVDS vs. CMOS and DDR vs. SDR. There is a static bias in the analog supply, while the remaining power dissipation is linearly related to the sample rate. The output supply dissipation changes to a lesser degree in LVDS mode, but is more strongly related to the clock frequency in CMOS mode.

#### Nap/Sleep

Portions of the device may be shut down to save power during times when operation of the ADC is not required. Two power saving modes are available: Nap, and Sleep. Nap mode reduces power dissipation to less than 134mW and recovers to normal operation in approximately 1µs. Sleep mode reduces power dissipation to less than 14mW but requires 1ms to recover.

All digital outputs (Data, CLKOUT and OR) are placed in a high impedance state during Nap or Sleep. The input clock should remain running and at a fixed frequency during Nap or Sleep. Recovery time from Nap mode will increase if the clock is stopped, since the internal DLL can take up to 52µs to regain lock at 250MSPS.

By default after the device is powered on, the operational state is controlled by the NAPSLP pin as shown in Table 3.

| NAPSLP Pin | Mode   |
|------------|--------|
| AVSS       | Normal |
| Float      | Sleep  |
| AVDD       | Nap    |

#### Table 3. NAPSLP Pin Settings

The power down mode can also be controlled through the SPI port, which overrides the NAPSLP pin

setting. Details on this are contained in the **Serial Peripheral Interface** section. This is an indexed function when controlled from the SPI, but a global function when driven from the pin.

## Data Format

Output data can be presented in three formats: two's complement, Gray code and offset binary. The data format is selected via the OUTFMT pin as shown in Table 4.

| OUTFMT Pin | Mode             |
|------------|------------------|
| AVSS       | Offset Binary    |
| Float      | Two's Complement |
| AVDD       | Gray Code        |

Table 4. OUTFMT Pin Settings

The data format can also be controlled through the SPI port, which overrides the OUTFMT pin setting. Details on this are contained in the **Serial Peripheral Interface** section.

Offset binary coding maps the most negative input voltage to code 0x000 (all zeros) and the most positive input to 0xFFF (all ones). Two's complement coding simply complements the MSB of the offset binary representation.

When calculating Gray code the MSB is unchanged. The remaining bits are computed as the XOR of the current bit position and the next most significant bit. Figure 33 shows this operation.

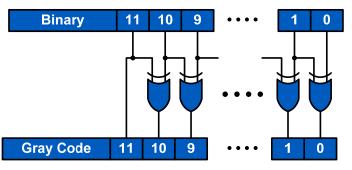


Figure 33. Binary to Gray Code Conversion

Converting back to offset binary from Gray code must be done recursively, using the result of each bit for the next lower bit as shown in Figure 34.



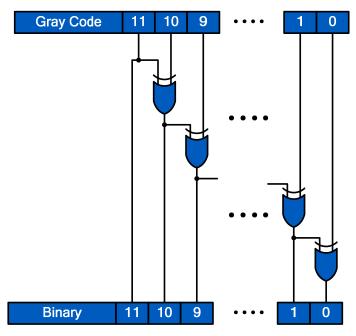


Figure 34. Gray Code to Binary Conversion

Mapping of the input voltage to the various data formats is shown in Table 5.

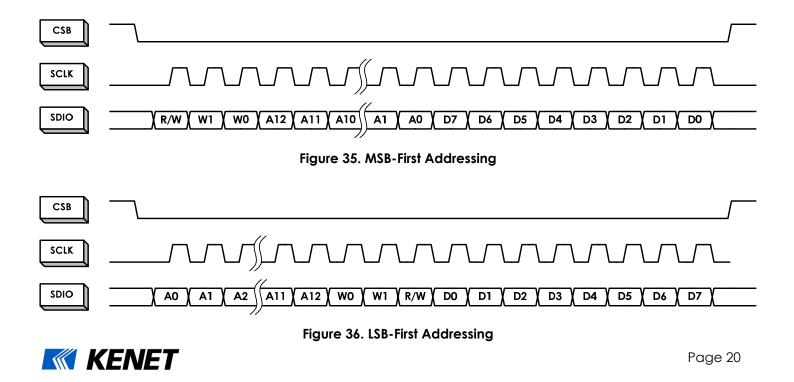
| Input<br>Voltage      | Offset<br>Binary | Two's<br>Complement | Gray<br>Code |
|-----------------------|------------------|---------------------|--------------|
| –Full Scale           | 000000000000     | 100000000000        | 000000000000 |
| –Full Scale<br>+ 1LSB | 00000000001      | 10000000001         | 00000000001  |
| Mid-Scale             | 100000000000     | 000000000000        | 110000000000 |
| +Full Scale<br>– 1LSB | 111111111110     | 011111111110        | 10000000001  |
| +Full Scale           | 1111111111111    | 011111111111        | 100000000000 |

| Table 5. | Input V | oltaae to | Output | Code | Mapping |
|----------|---------|-----------|--------|------|---------|
| 10010 0. |         | onage ie  | 00.00  | 0040 | mapping |

## Serial Peripheral Interface

A serial peripheral interface (SPI) bus is used to facilitate configuration of the device and to optimize performance. The SPI bus consists of chip select (CSB), serial clock (SCLK) serial data input (SDI), and serial data input/output (SDIO). The maximum SCLK rate is equal to the ADC sample rate ( $f_{SAMPLE}$ ) divided by 16 for write operations and  $f_{SAMPLE}$  divided by 66 for reads. At  $f_{SAMPLE} = 250$ MHz, maximum SCLK is 15.63MHz for writing and 3.79MHz for write operations. There is no minimum SCLK rate.

The following sections describe various registers that are used to configure the SPI or adjust performance or functional parameters. Many registers in the available address space (0x00 to 0xFF) are not defined in



this document. Additionally, within a defined register there may be certain bits or bit combinations that are reserved. Undefined registers and undefined values within defined registers are reserved and should not be selected. Setting any reserved register or value may produce indeterminate results.

#### SPI Physical Interface

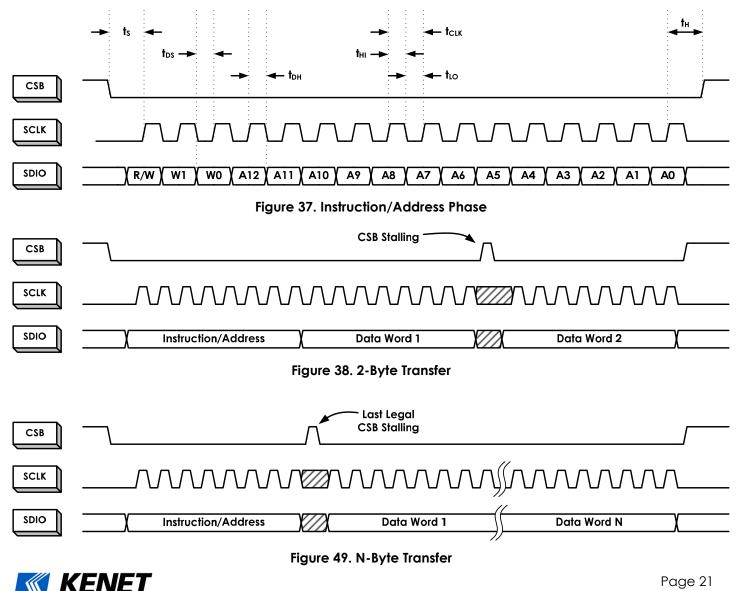
The serial clock pin (SCLK) provides synchronization for the data transfer. By default, all data is presented on the serial data input/output (SDIO) pin in threewire mode. The state of the SDIO pin is set automatically in the communication protocol (described below). A dedicated serial data output pin (SDO) can be activated by setting 0x00[7] high to allow operation in four-wire mode.

The SPI port operates in a half duplex master/slave configuration, with the KAD5512HP functioning as a

slave. Multiple slave devices can interface to a single master in four-wire mode only, since the SDIO output of an unaddressed device is asserted in three wire mode.

The chip-select bar (CSB) pin determines when a slave device is being addressed. Multiple slave devices can be written to concurrently, but only one slave device can be read from at a given time (again, only in four-wire mode). If multiple slave devices are selected for reading at the same time, the results will be indeterminate.

The communication protocol begins with an instruction/address phase. The first rising SCLK edge following a high to low transition on CSB determines the beginning of the two-byte instruction/address command. Data can be presented in MSB-first order or LSB-first order. The default is MSB-first, but this can be changed by setting 0x00[6] high. Figures 35 and 36 show the appropriate bit ordering for the MSB-first



and LSB-first modes, respectively. In MSB-first mode the address is incremented for multi-byte transfers, while in LSB-first mode it's decremented.

In the default mode the MSB is R/W, which determines if the data is to be read (active high) or written. The next two bits, W1 and W0, determine the number of data bytes to be read or written (see Table 6). The lower 13 bits contain the first address for the data transfer. This relationship is illustrated in Figure 37, and timing values are given in the **Switching Specifications** section.

After the instruction/address bytes have been read, the appropriate number of data bytes are written to or read from the ADC (based on the R/W bit status). The data transfer will continue as long as CSB remains low and SCLK is active. Stalling of the CSB pin is allowed at any byte boundary (instruction/address or data) if the number of bytes being transferred is three or less. For transfers of four bytes or more, CSB is allowed stall in the middle of the instruction/address bytes or before the first data byte. If CSB transitions to a high state after that point the state machine will reset and terminate the data transfer.

| [W1:W0] | Bytes Transferred |
|---------|-------------------|
| 00      | 1                 |
| 01      | 2                 |
| 10      | 3                 |
| 11      | 4 or more         |

#### Table 6. Byte Transfer Selection

Figures 38 and 39 illustrate the timing relationships for 2-byte and N-byte transfers, respectively. The operation for a 3-byte transfer can be inferred from these diagrams.

### **SPI** Configuration

#### Address 0x00: chip\_port\_config

Bit ordering and SPI reset are controlled by this register. Bit order can be selected as MSB to LSB (MSB first) or LSB to MSB (LSB first) to accommodate various microcontrollers.

Bit 7 SDO Active

Bit 6 LSB First

Setting this bit high configures the SPI to interpret serial data as arriving in LSB to MSB order.

Bit 5 Soft Reset

Setting this bit high resets all SPI registers to default values.

Bit 4 Reserved

This bit should always be set high.

Bits 3:0 These bits should always mirror bits 4:7 to avoid ambiguity in bit ordering.

#### Address 0x02: burst\_end

If a series of sequential registers are to be set, burst mode can improve throughput by eliminating redundant addressing. In 3-wire SPI mode the burst is ended by pulling the CSB pin high. If the device is operated in 2-wire mode the CSB pin is not available. In that case, setting the burst\_end address determines the end of the transfer. During a write operation, the user must be cautious to transmit the correct number of bytes based on the starting and ending addresses.

Bits 7:0 Burst End Address

This register value determines the ending address of the burst data.

## **Device Information**

#### Address 0x08: chip\_id

#### Address 0x09: chip\_version

The generic die identifier and a revision number, respectively, can be read from these two registers.

### Indexed Device Configuration/ Control

#### Address 0x10: device\_index\_A

A common SPI map, which can accommodate single-channel or multi-channel devices, is used for all Kenet ADC products. Certain configuration commands (identified as Indexed in the SPI map) can be executed on a per-converter basis. This register determines which converter is being addressed for an Indexed command. It is important to note that only a single converter can be addressed at a time.

This register defaults to 00h, indicating that no ADC is addressed. Error code 'AD' is returned if any indexed register is read from without properly setting device\_index\_A.

#### Address 0x20: offset\_coarse

#### Address 0x21: offset\_fine

The input offset of each ADC core can be adjusted in fine and coarse steps. Both adjustments are made via an 8-bit word as detailed in Table 7.



The default value of each register will be the result of the self-calibration after initial power-up. If a register is to be incremented or decremented, the user should first read the register value then write the incremented or decremented value back to the same register.

| Parameter          | 0x20[7:0]<br>Coarse Offset | 0x21[7:0]<br>Fine Offset |
|--------------------|----------------------------|--------------------------|
| Steps              | 255                        | 255                      |
| –Full Scale (0x00) | -133LSB (-47mV)            | -5LSB (-1.75mV)          |
| Mid-Scale (0x80)   | 0.0LSB (0.0mV)             | 0.0LSB                   |
| +Full Scale (0xFF) | +133LSB (+47mV)            | +5LSB (+1.75mV)          |
| Nominal Step Size  | 1.04LSB (0.37mV)           | 0.04LSB (0.014mV)        |

#### Table 7. Offset Adjustments

Address 0x22: gain\_coarse

#### Address 0x23: gain medium

#### Address 0x24: gain\_fine

Gain of each ADC core can be adjusted in coarse, medium and fine steps. Coarse gain is a 4-bit adjustment while medium and fine are 8-bit.

The default value of each register will be the result of the self-calibration after initial power-up. If a register is to be incremented or decremented, the user should first read the register value then write the incremented or decremented value back to the same register.

| 0x22[3:0] | Nominal Coarse<br>Gain Adjust |
|-----------|-------------------------------|
| 1100      | 4.2%                          |
| 1000      | 2.8%                          |
| 0100      | 1.4%                          |
| 0000      | 0.0%                          |
| 0001      | -1.4%                         |
| 0010      | -2.8%                         |
| 0011      | -4.2%                         |

Table 8. Coarse Gain Adjustment

| Parameter          | 0x23[7:0]<br>Medium Gain | 0x24[7:0]<br>Fine Gain |
|--------------------|--------------------------|------------------------|
| Steps              | 256                      | 256                    |
| –Full Scale (0x00) | -2%                      | -0.2%                  |
| Mid-Scale (0x80)   | 0.0%                     | 0.0%                   |
| +Full Scale (0xFF) | +2%                      | +0.2%                  |
| Nominal Step Size  | 0.016%                   | 0.0016%                |

#### Table 9. Medium and Fine Gain Adjustments

#### Address 0x25: modes

Two distinct reduced power modes can be selected. By default, the tri-level NAPSLP pin can select normal operation, nap or sleep modes (refer to **Nap/Sleep** section). This functionality can be overridden and controlled through the SPI. This is an indexed function when controlled from the SPI, but a global function when driven from the pin. This register is not changed by a Soft Reset.

| Value | 0x25[2:0]<br>Power Down Mode |
|-------|------------------------------|
| 000   | Pin Control                  |
| 001   | Normal Operation             |
| 010   | Nap Mode                     |
| 100   | Sleep Mode                   |

#### Table 10. Power Down Control

#### **Global Device Configuration/Control**

#### Address 0x70: skew\_diff

The value in the skew\_diff register adjusts the timing skew between the two ADCs cores. The nominal range and resolution of this adjustment are given in Table 11. The default value of this register after powerup is 80h.

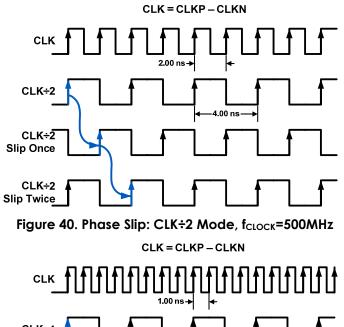
| Parameter          | 0x70[7:0]<br>Differential Skew |
|--------------------|--------------------------------|
| Steps              | 256                            |
| –Full Scale (0x00) | -6.5ps                         |
| Mid–Scale (0x80)   | 0.0ps                          |
| +Full Scale (0xFF) | +6.5ps                         |
| Nominal Step Size  | 51fs                           |

Table 11. Differential Skew Adjustment



#### Address 0x71: phase slip

When using the clock divider, it's not possible to deter- Address 0x73: output mode A mine the synchronization of the incoming and divided clock phases. This is particularly important when multiple ADCs are used in a time-interleaved system. The phase slip feature allows the rising edge of the divided clock to be advanced by one input clock cycle, as shown in Figures 40 and 41. This register is self-clearing.



#### CLK÷4 .00 ns CLK÷4 Slip Once CLK+4 Slip Twice

#### Figure 41. Phase Slip: CLK+4 Mode, fclock=1000MHz

#### Address 0x72: clock\_divide

The KAD5512HP has a selectable clock divider that Address 0x74: output\_mode\_B can be set to divide by four, two or one (no division). By default, the tri-level CLKDIV pin selects the divisor (refer to **Clock Input** section). This functionality can be overridden and controlled through the SPI, as shown in Table 12. This register is not changed by a Soft Reset.

| Value | 0x72[2:0]<br>Clock Divider |
|-------|----------------------------|
| 000   | Pin Control                |
| 001   | Divide by 1                |
| 010   | Divide by 2                |
| 100   | Divide by 4                |

#### Table 12. Clock Divider Selection

The output\_mode\_A register controls the physical output format of the data, as well as the logical coding. The KAD5512HP can present output data in two physical formats: LVDS or LVCMOS. Additionally, the drive strength in LVDS mode can be set high (3mA) or low (2mA). By default, the tri-level OUTMODE pin selects the mode and drive level (refer to Digital Outputs section). This functionality can be overridden and controlled through the SPI, as shown in Table 13.

Data can be coded in three possible formats: two's complement, Gray code or offset binary. By default, the tri-level OUTFMT pin selects the data format (refer to Data Format section). This functionality can be overridden and controlled through the SPI, as shown in Table 14.

| Value | 0x93[7:5]   |  |  |  |  |
|-------|-------------|--|--|--|--|
| 000   | Pin Control |  |  |  |  |
| 001   | LVDS 2mA    |  |  |  |  |
| 010   | LVDS 3mA    |  |  |  |  |
| 100   | LVCMOS      |  |  |  |  |

This register is not changed by a Soft Reset.

#### Table 13. Output Mode Control

| Value | 0x93[2:0]<br>Output Format |
|-------|----------------------------|
| 000   | Pin Control                |
| 001   | Two's Complement           |
| 010   | Gray Code                  |
| 100   | Offset Binary              |

#### Table 14. Output Format Control

#### Address 0x75: config\_status

Bit 6 DLL Range

> This bit sets the DLL operating range to fast (default) or slow.

Bit 4 **DDR Enable** 

> Setting this bit enables Double Data-Rate mode.

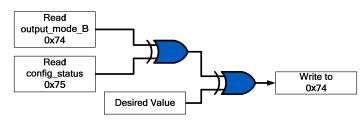
Internal clock signals are generated by a delaylocked loop (DLL), which has a finite operating range. Table 15 shows the allowable sample rate ranges for the slow and fast settings.



| DLL Range | MIN | MAX    | Unit |
|-----------|-----|--------|------|
| Slow      | 40  | 100    | MSPS |
| Fast      | 80  | fs MAX | MSPS |

Table 15. DLL Ranges

The output\_mode\_B and config\_status registers are used in conjunction to enable DDR mode and select the frequency range of the DLL clock generator. The method of setting these options is different from the other registers.



#### Figure 42. Setting output mode B register

The procedure for setting output\_mode\_B is shown in Address 0xC3: user\_patt2\_msb Figure 42. Read the contents of output\_mode\_B and These registers define the lower and upper eight bits, config\_status and XOR them. Then XOR this result with the desired value for output\_mode\_B and write that XOR result to the register.

#### **Device** Test

The KAD5512HP can produce preset or user defined patterns on the digital outputs to facilitate in-situ testing. A static word can be placed on the output bus, or two different words can alternate. In the alternate mode, the values defined as Word 1 and Word 2 (as shown in Table 16) are set on the output bus on alternating clock phases. The test mode is enabled asynchronously to the sample clock, therefore several sample clock cycles may elapse before the data is present on the output bus.

#### Address 0xC0: test io

Bits 7:6 User Test Mode

These bits set the test mode to static (0x00) or alternate (0x01) mode. Other values are reserved.

The four LSBs in this register (Output Test Mode) determine the test pattern in combination with registers 0xC2 through 0xC5. Refer to Table 17.

| Value | 0xC0[3:0]<br>Output Test Mode | Word 1     | Word 2     |  |
|-------|-------------------------------|------------|------------|--|
| 0000  | Off                           |            |            |  |
| 0001  | Midscale                      | 0x8000     | N/A        |  |
| 0010  | Positive Full-Scale           | OxFFFF     | N/A        |  |
| 0011  | Negative Full-Scale           | 0x0000     | N/A        |  |
| 0100  | Checkerboard                  | 0xAAAA     | 0x5555     |  |
| 0101  | Reserved                      | N/A        | N/A        |  |
| 0110  | Reserved                      | N/A        | N/A        |  |
| 0111  | One/Zero                      | OxFFFF     | 0x0000     |  |
| 1000  | User Pattern                  | user_patt1 | user_patt2 |  |

#### Table 16. Output Test Modes

Address 0xC2: user patt1 lsb

#### Address 0xC3: user\_patt1\_msb

These registers define the lower and upper eight bits, respectively, of the first user-defined test word.

#### Address 0xC2: user patt2 lsb

respectively, of the second user-defined test word.



## **SPI Memory Map**

|                               | Addr<br>(Hex)  | Parameter Name    | Bit 7 (MSB)                        | Bit 6      | Bit 5      | Bit 4              | Bit 3                         | Bit 2                         | Bit 1         | Bit O (LSB)   | Def. Value<br>(Hex) |          |
|-------------------------------|----------------|-------------------|------------------------------------|------------|------------|--------------------|-------------------------------|-------------------------------|---------------|---------------|---------------------|----------|
| fig                           | 00             | port_config       | SDO Active                         | LSB First  | Soft Reset |                    |                               | Mirror (bit5)                 | Mirror (bit6) | Mirror (bit7) | 00h                 | G        |
| SPI Config                    | 01             | reserved          |                                    |            |            | Re                 | served                        |                               |               |               |                     |          |
| 0                             | 02             | burst_end         |                                    |            |            | Burst end          | address [7:                   | D]                            |               |               | 00h                 | G        |
| SP                            | 03-07          | reserved Reserved |                                    |            |            |                    |                               |                               |               |               |                     |          |
| Info                          | 08             | chip_id           | Chip ID #                          |            |            |                    |                               |                               | Read only     | G             |                     |          |
| Ц                             | 09             | chip_version      |                                    |            |            |                    |                               | Read only                     | G             |               |                     |          |
|                               | 10             | device_index_A    |                                    |            | Res        | erved              |                               |                               | ADC01         | ADC00         | 00h                 |          |
| 2                             | 11-1F          | reserved          | Reserved                           |            |            |                    |                               |                               |               |               |                     |          |
| Indexed Device Config/Control | 20             | offset_coarse     | Coarse Offset                      |            |            |                    |                               |                               |               |               |                     | I        |
|                               | 21             | offset_fine       | Fine Offset                        |            |            |                    |                               |                               |               | cal. value    |                     |          |
| fig                           | 22             | gain_coarse       |                                    | Re         | served     |                    |                               | Coc                           | irse Gain     |               | cal. value          |          |
| ğ                             | 23             | gain_medium       |                                    |            |            |                    | um Gain                       |                               |               |               | cal. value          |          |
| e                             | 24<br>25       | gain_fine         |                                    |            |            | Fine               | e Gain                        | Baurar Dave                   | - Mada [2:0]  |               | cal. value          |          |
| Ś.                            | 25             | modes             |                                    |            |            |                    |                               | 000=Pin Co                    | n Mode [2:0]  |               | 00h<br>NOT          |          |
| De                            |                |                   |                                    |            |            |                    |                               |                               | l Operation   |               | affected by         |          |
| σ                             |                |                   |                                    |            |            |                    |                               | 010=Nap                       | Operation     |               | Soft Reset          |          |
| exe<br>exe                    |                |                   |                                    |            |            |                    |                               | 100=Sleep                     |               |               | 3011 Kesel          |          |
| de                            |                |                   |                                    |            |            |                    |                               | other code                    | s=reserved    |               |                     |          |
| 7                             | 26-5F          | reserved          |                                    |            |            | Po                 | served                        |                               | 5 10501700    |               |                     |          |
|                               | 28-3F<br>60-6F | reserved          |                                    |            |            |                    |                               |                               |               |               |                     |          |
|                               |                |                   |                                    |            |            |                    | served                        |                               |               |               |                     |          |
|                               | 70             | reserved          |                                    |            |            |                    | served                        |                               |               | Next Class    | 0.01-               | <u> </u> |
|                               | 71             | phase_slip        |                                    |            |            | Reserved           |                               |                               |               | Next Clock    | 00h                 | G        |
|                               | 72             | clock_divide      | ļ                                  |            |            |                    |                               | Clock Divid                   | o [2:0]       | Edge          | 00h                 | G        |
|                               | 12             | CIOCK_UIVIUE      |                                    |            |            |                    |                               | 000=Pin Co                    |               |               | NOT                 | -        |
| _                             |                |                   |                                    |            |            |                    |                               |                               |               |               | affected by         |          |
| to                            |                |                   | 001=divide by 1<br>010=divide by 2 |            |            |                    |                               |                               |               | Soft Reset    |                     |          |
| uo                            |                |                   |                                    |            |            |                    |                               | 100=divide                    |               |               | 3011 Kesel          |          |
| Global Device Config/Control  |                |                   |                                    |            |            |                    |                               | other code                    | ,             |               |                     |          |
| fig                           | 73             | output_mode_A     | Output Mode                        | a [2·0]    |            | 1                  |                               | Output Forn                   |               |               | 00h                 | G        |
| Š                             | /5             | ooipoi_mode_A     | 000=Pin Con                        |            |            |                    |                               | 000=Pin Co                    |               |               | NOT                 | -        |
| e                             |                |                   | 001=LVDS 2n                        |            |            |                    |                               |                               | Complement    |               | affected by         |          |
| Ś.                            |                |                   | 010=LVDS 3n                        |            |            |                    |                               | 010=Gray C                    |               |               | Soft Reset          |          |
| De                            |                |                   | 100=LVCMO                          |            |            |                    |                               | 100=Offset                    |               |               |                     |          |
| ō                             |                |                   | other codes                        |            |            |                    |                               | other code                    |               |               |                     |          |
| ą                             | 74             | output_mode_B     |                                    | DLL Range  |            | DDR Enable         |                               |                               |               |               | 00h                 | G        |
| Ū                             | <i>.</i>       | oolpol_modo_p     |                                    | 0=fast     |            | D D I C LI G D I O |                               |                               |               |               | NOT                 | _        |
|                               |                |                   |                                    | 1=slow     |            |                    |                               |                               |               |               | affected by         |          |
|                               |                |                   |                                    |            |            |                    |                               |                               |               |               | Soft Reset          |          |
|                               |                |                   |                                    |            |            |                    |                               |                               |               |               |                     |          |
|                               | 75             | config_status     |                                    | XOR Result | t          | XOR Result         |                               |                               |               |               | Read Only           | G        |
|                               | 76-BF          | reserved          | Reserved                           |            |            |                    |                               |                               |               |               |                     |          |
|                               | C0             | test_io           | User Test Mo                       | de [2:0]   | Reset PN   | Reset PN           | set PN Output Test Mode [3:0] |                               |               |               | 00h                 | G        |
|                               |                | 00=Single         |                                    | Long Gen   | Short Gen  | 0=Off              | 7=One/Zero Word Toggle        |                               |               |               |                     |          |
|                               |                |                   | 01=Alternate                       |            |            |                    |                               | 1=Midscale Short 8=User Input |               |               |                     |          |
|                               |                |                   | 10=Single Or                       | nce        |            |                    | 2=+FS Short<br>3=-FS Short    |                               |               |               |                     |          |
|                               |                |                   | 11=Alternate                       | Once       |            |                    |                               |                               |               |               |                     |          |
| est                           |                |                   |                                    |            |            |                    | 4=Checker Board               |                               |               |               |                     |          |
| è Té                          |                |                   | 5=reserved                         |            |            |                    |                               |                               |               |               |                     |          |
| ,ice                          |                |                   | 6=reserved                         |            |            |                    |                               |                               |               |               |                     |          |
| Device Test                   | Cl             | Percented         | Reserved                           |            |            |                    |                               | 00h                           |               |               |                     |          |
|                               | C1             | Reserved          | D7                                 | D/         | D.E        | 1                  |                               | DO.                           | 01            | Ino           |                     | G        |
|                               | C2             | user_patt1_lsb    | B7                                 | B6         | B5         | B4                 | B3                            | B2                            | B1            | BO            | 00h                 | G        |
|                               | C3             | user_patt1_msb    | B15                                | B14        | B13        | B12                | B11                           | B10                           | B9            | B8            | 00h                 | G        |
|                               | C4             | user_patt2_lsb    | B7                                 | B6         | B5         | B4                 | B3                            | B2                            | B1            | BO            | 00h                 |          |
|                               | C5             | user_patt2_msb    | B15                                | B14        | B13        | B12                | B11                           | B10                           | B9            | B8            | 00h                 | G        |
|                               | C6-FF          | reserved          | Reserved                           |            |            |                    |                               |                               |               |               |                     |          |

Table 17. SPI Memory Map



## **Equivalent Circuits**

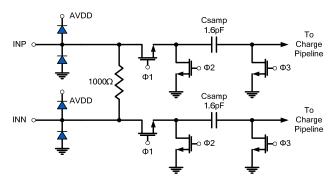
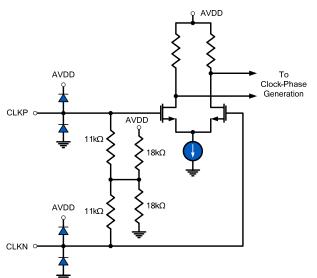


Figure 43. Analog Inputs



#### Figure 44. Clock Inputs

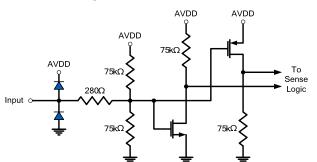


Figure 45. Tri-Level Digital Inputs

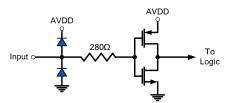


Figure 46. Digital Inputs

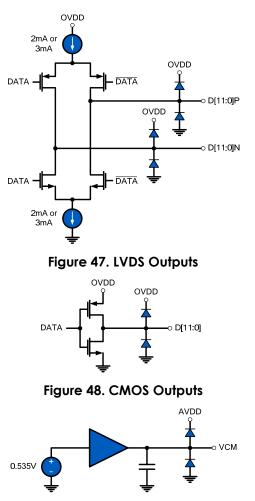


Figure 49. VCM\_OUT Output

## Layout Considerations

## **Split Ground and Power Planes**

Data converters operating at high sampling frequencies require extra care in PC board layout. Many complex board designs benefit from isolating the analog and digital sections. Analog supply and ground planes should be laid out under signal and clock inputs. Locate the digital planes under outputs and logic pins. Grounds should be joined under the chip.

### **Clock Input Considerations**

Use matched transmission lines to the transformer inputs for the analog input and clock signals. Locate transformers and terminations as close to the chip as possible.



#### Exposed Paddle

The exposed paddle must be electrically connected to analog ground (AVSS) and should be connected to a large copper plane using numerous vias for optimal thermal performance.

#### **Bypass and Filtering**

Bulk capacitors should have low equivalent series resistance. Tantalum is a good choice. For best performance, keep ceramic bypass capacitors very close to device pins. Longer traces will increase inductance, resulting in diminished dynamic performance and accuracy. Make sure that connections to ground are direct and low impedance. Avoid forming ground loops.

## LVDS Outputs

Output traces and connections must be designed for  $50\Omega$  ( $100\Omega$  differential) characteristic impedance. Keep traces direct and minimize bends where possible. Avoid crossing ground and power-plane breaks with signal traces.

### **LVCMOS** Outputs

Output traces and connections must be designed for  $50\Omega$  characteristic impedance.

#### **Unused Inputs**

Standard logic inputs (RESETN, CSB, SCLK, SDIO, SDO) which will not be operated do not require connection to ensure optimal ADC performance. These inputs can be left floating if they are not used. Tri-level inputs (NAPSLP, OUTMODE, OUTFMT, CLKDIV) accept a floating input as a valid state, and therefore should be biased according to the desired functionality.

## Definitions

**Analog Input Bandwidth** is the analog input frequency at which the spectral output power at the fundamental frequency (as determined by FFT analysis) is reduced by 3dB from its full-scale low-frequency value. This is also referred to as Full Power Bandwidth.

Aperture Delay or Sampling Delay is the time required after the rise of the clock input for the sampling switch to open, at which time the signal is held for conversion.

Aperture Jitter is the RMS variation in aperture delay for a set of samples.

**Clock Duty Cycle** is the ratio of the time the clock wave is at logic high to the total time of one clock period.

**Differential Non-Linearity (DNL)** is the deviation of any code width from an ideal 1 LSB step.

**Effective Number of Bits (ENOB)** is an alternate method of specifying Signal to Noise-and-Distortion Ratio (SINAD). In dB, it is calculated as: ENOB = (SINAD-1.76) / 6.02

**Gain Error** is the ratio of the difference between the voltages that cause the lowest and highest code transitions to the full-scale voltage less 2 LSB. It is typically expressed in percent.

**Integral Non-Linearity (INL)** is the maximum deviation of the ADC's transfer function from a best fit line determined by a least squares curve fit of that transfer function, measured in units of LSBs.

**Least Significant Bit (LSB)** is the bit that has the smallest value or weight in a digital word. Its value in terms of input voltage is  $V_{FS}/(2^{N-1})$  where N is the resolution in bits.

**Missing Codes** are output codes that are skipped and will never appear at the ADC output. These codes cannot be reached with any input value.

Most Significant Bit (MSB) is the bit that has the largest value or weight.

**Pipeline Delay** is the number of clock cycles between the initiation of a conversion and the appearance at the output pins of the data.

**Power Supply Rejection Ratio (PSRR)** is the ratio of the observed magnitude of a spur in the ADC FFT, caused by an AC signal superimposed on the power supply voltage.

**Signal to Noise-and-Distortion (SINAD)** is the ratio of the RMS signal amplitude to the RMS sum of all other spectral components below one half the clock frequency, including harmonics but excluding DC.

**Signal-to-Noise Ratio** (without Harmonics) is the ratio of the RMS signal amplitude to the RMS sum of all other spectral components below one-half the sampling frequency, excluding harmonics and DC.

SNR and SINAD are either given in units of dB when the power of the fundamental is used as the reference, or dBFS (dB to full scale) when the converter's full-scale input power is used as the reference.

**Spurious-Free-Dynamic Range (SFDR)** is the ratio of the RMS signal amplitude to the RMS value of the largest spurious spectral component. The largest spurious spectral component may or may not be a harmonic.



## **Outline Dimensions—72QFN**

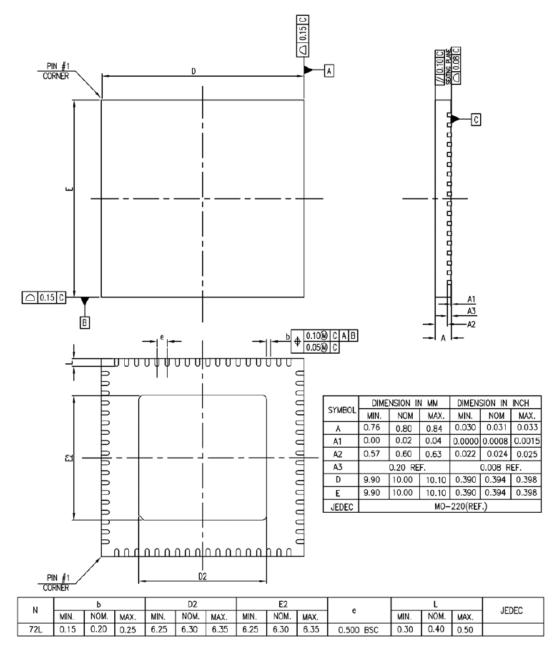




Figure 50. 72QFN Dimensions

## **Outline Dimensions—48QFN**

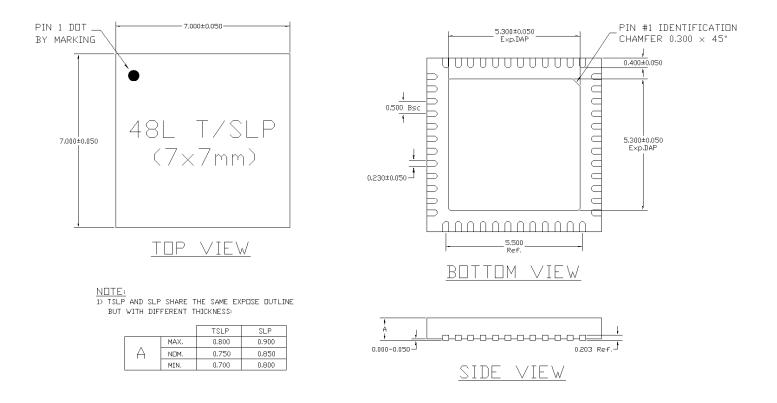


Figure 51. 48QFN Dimensions



## **Ordering Guide**



The KAD5512HP is compliant with EU directive 2002/95/EC regarding the Restriction of Hazardous Substances (RoHS). Contact Kenet for a materials declaration for this product.

| Model           | Speed   | Package | Temp. Range    |  |  |
|-----------------|---------|---------|----------------|--|--|
| KAD5512HP-25Q72 | 250MSPS | 72-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-21Q72 | 210MSPS | 72-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-17Q72 | 170MSPS | 72-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-12Q72 | 125MSPS | 72-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-25Q48 | 250MSPS | 48-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-21Q48 | 210MSPS | 48-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-17Q48 | 170MSPS | 48-QFN  | -40°C to +85°C |  |  |
| KAD5512HP-12Q48 | 125MSPS | 48-QFN  | -40°C to +85°C |  |  |

## **Revision History**

30-Jul-08: Rev 1 Initial Release of Production Datasheet

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